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August 2014

FDPF44N25T

N-Channel UniFET™ MOSFET

250 V, 44 A, 69 mΩ

Features

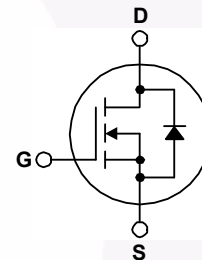
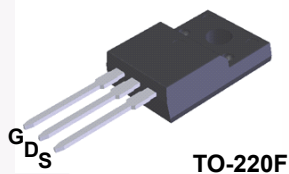
- $R_{DS(on)} = 69 \text{ m}\Omega$ (Max.) @ $V_{GS} = 10 \text{ V}$, $I_D = 22 \text{ A}$
- Low Gate Charge (Typ. 47 nC)
- Low C_{rss} (Typ. 60 pF)

Applications

- PDP TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

Description

UniFET™ MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.



Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	FDPF44N25T FDPF44N25TRDTU	Unit
V_{DSS}	Drain-Source Voltage	250	V
I_D	Drain Current	44*	A
	- Continuous ($T_C = 25^\circ\text{C}$)	26.4*	A
	- Continuous ($T_C = 100^\circ\text{C}$)		
I_{DM}	Drain Current	176*	A
	- Pulsed (Note 1)		
V_{GSS}	Gate-Source voltage	± 30	V
E_{AS}	Single Pulsed Avalanche Energy	2055	mJ
	(Note 2)		
I_{AR}	Avalanche Current	44	A
	(Note 1)		
E_{AR}	Repetitive Avalanche Energy	30.7	mJ
	(Note 1)		
dv/dt	Peak Diode Recovery dv/d	4.5	V/ns
	(Note 3)		
P_D	Power Dissipation	38	W
	($T_C = 25^\circ\text{C}$)	0.3	W/°C
	- Derate Above 25°C		
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +150	°C
T_L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds	300	°C

*Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	FDPF44N25T FDPF44N25TRDTU	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	3.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDPF44N25T	FDPF44N25T	TO-220F	Tube	N/A	N/A	50 units
FDPF44N25TRDTU	FDPF44N25T	TO-220F (LG-formed)	Tube	N/A	N/A	50 units

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit	
Off Characteristics							
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}, T_J = 25^\circ\text{C}$	250	--	--	V	
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\ \mu\text{A}$, Referenced to 25°C	--	0.25	--	$\text{V}/^\circ\text{C}$	
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 250\text{ V}, V_{GS} = 0\text{ V}$ $V_{DS} = 200\text{ V}, T_C = 125^\circ\text{C}$	--	--	1 10	μA μA	
I_{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 30\text{ V}, V_{DS} = 0\text{ V}$	--	--	100	nA	
I_{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30\text{ V}, V_{DS} = 0\text{ V}$	--	--	-100	nA	
On Characteristics							
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	3.0	--	5.0	V	
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}, I_D = 22\text{ A}$	--	0.058	0.069	Ω	
g_{FS}	Forward Transconductance	$V_{DS} = 40\text{ V}, I_D = 22\text{ A}$	--	32	--	S	
Dynamic Characteristics							
C_{iss}	Input Capacitance	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$	--	2210	2870	pF	
C_{oss}	Output Capacitance		--	450	585	pF	
C_{riss}	Reverse Transfer Capacitance		--	60	90	pF	
Switching Characteristics							
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 125\text{ V}, I_D = 44\text{ A},$ $R_G = 25\ \Omega$	--	53	117	ns	
t_r	Turn-On Rise Time		--	402	814	ns	
$t_{d(off)}$	Turn-Off Delay Time		(Note 4)	--	85	179	ns
t_f	Turn-Off Fall Time		(Note 4)	--	112	234	ns
Q_g	Total Gate Charge	$V_{DS} = 200\text{ V}, I_D = 44\text{ A},$ $V_{GS} = 10\text{ V}$	--	47	61	nC	
Q_{gs}	Gate-Source Charge		(Note 4)	--	18	--	nC
Q_{gd}	Gate-Drain Charge		(Note 4)	--	24	--	nC
Drain-Source Diode Characteristics and Maximum Ratings							
I_S	Maximum Continuous Drain-Source Diode Forward Current		--	--	44	A	
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	176	A	
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 44\text{ A}$	--	--	1.4	V	
t_{rr}	Reverse Recovery Time	$V_{GS} = 0\text{ V}, I_S = 44\text{ A},$ $di_F/dt = 100\text{ A}/\mu\text{s}$	--	195	--	ns	
Q_{rr}	Reverse Recovery Charge		--	1.8	--	μC	

Notes:

1. Repetitive rating: pulse-width limited by maximum junction temperature.
2. $L = 1.7\text{ mH}, I_{AS} = 44\text{ A}, V_{DD} = 50\text{ V}, R_G = 25\ \Omega$, starting $T_J = 25^\circ\text{C}$.
3. $I_{SD} \leq 44\text{ A}, di/dt \leq 200\text{ A}/\mu\text{s}, V_{DD} \leq BV_{DSS}$, starting $T_J = 25^\circ\text{C}$.
4. Essentially independent of operating temperature typical characteristics.

Typical Performance Characteristics

Figure 1. On-Region Characteristics

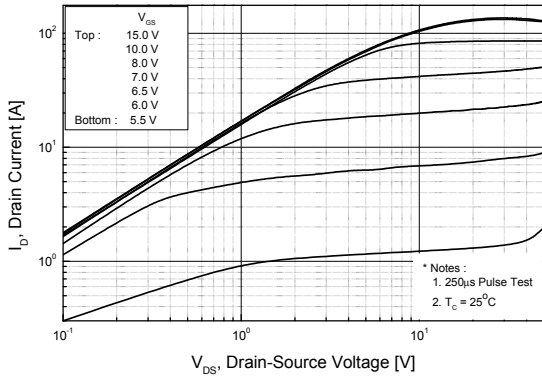


Figure 2. Transfer Characteristics

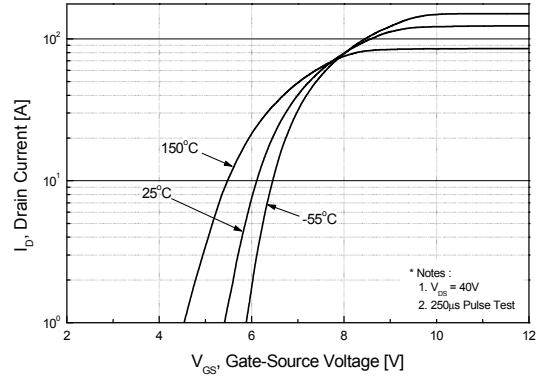


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

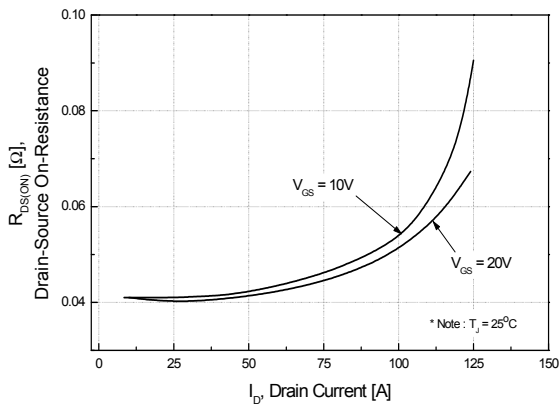


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

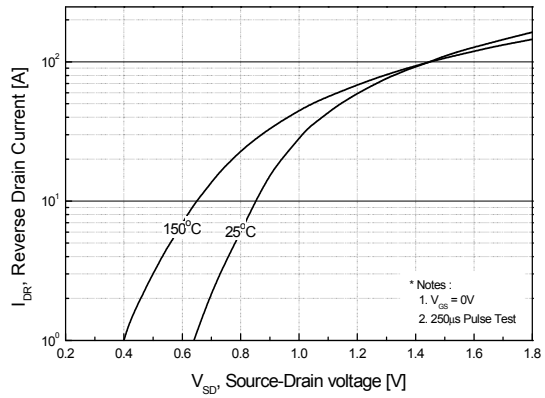


Figure 5. Capacitance Characteristics

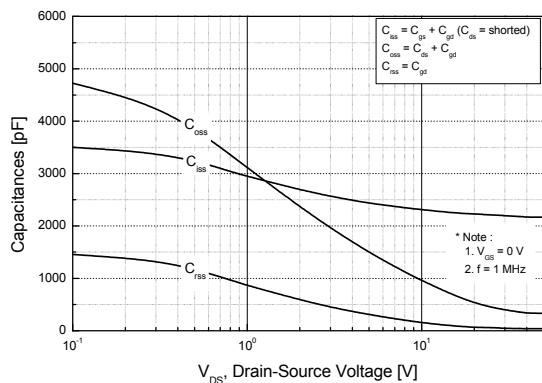
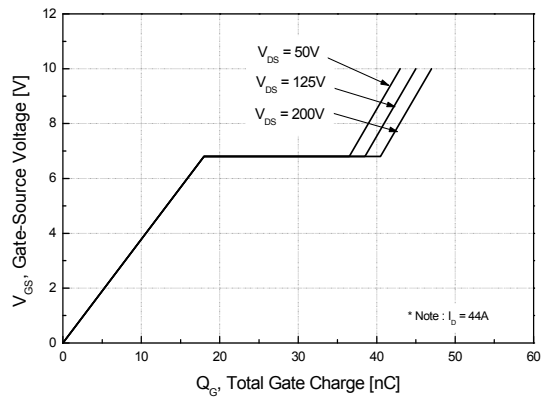


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

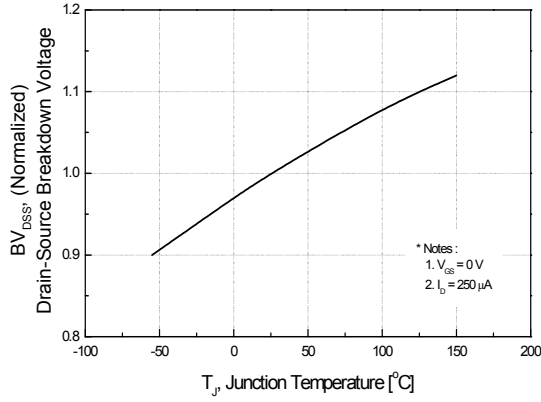


Figure 8. On-Resistance Variation vs. Temperature

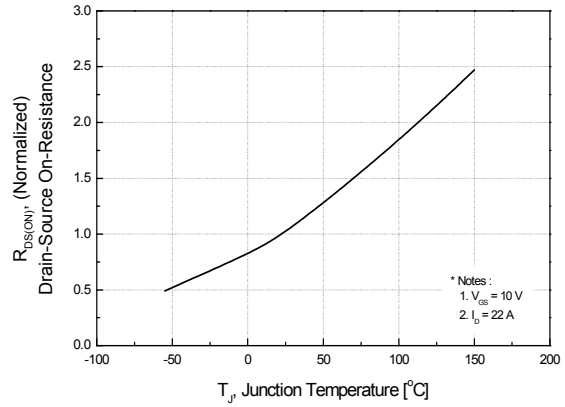


Figure 9. Maximum Safe Operating Area

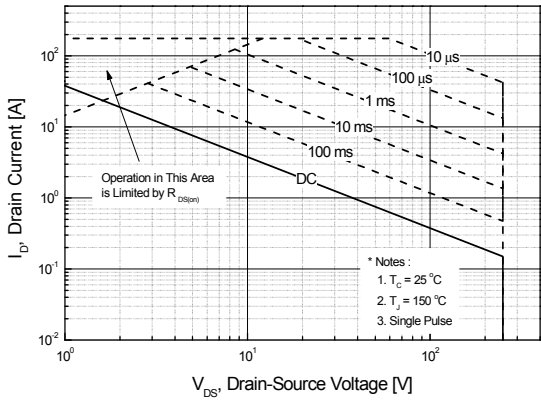


Figure 10. Maximum Drain Current vs. Case Temperature

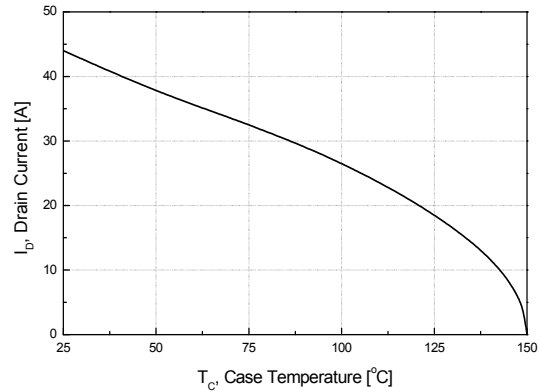
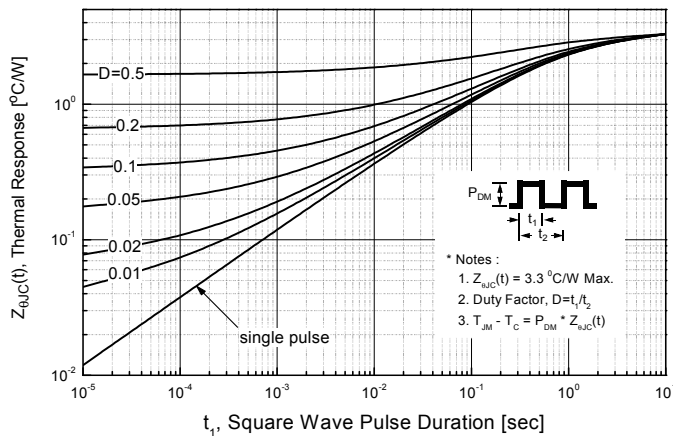


Figure 11. Transient Thermal Response Curve



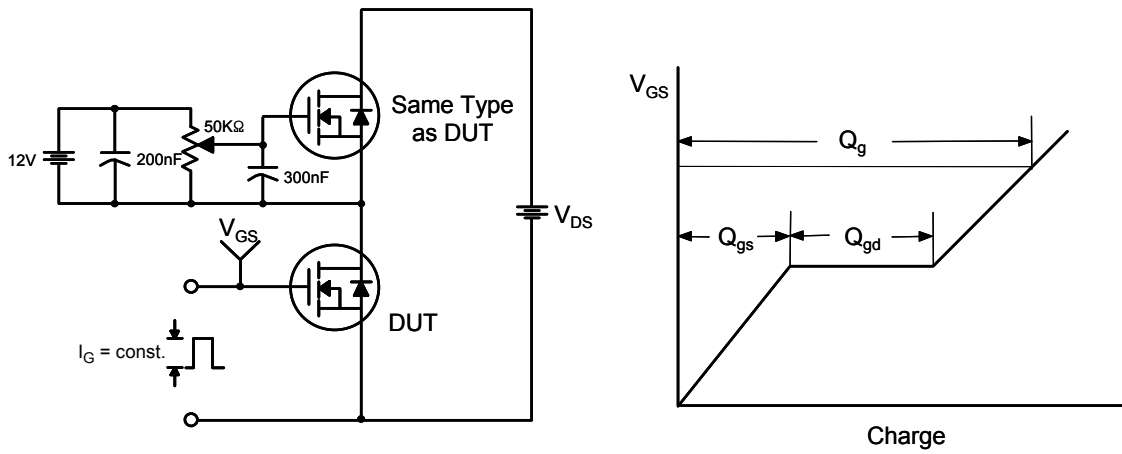


Figure 12. Gate Charge Test Circuit & Waveform

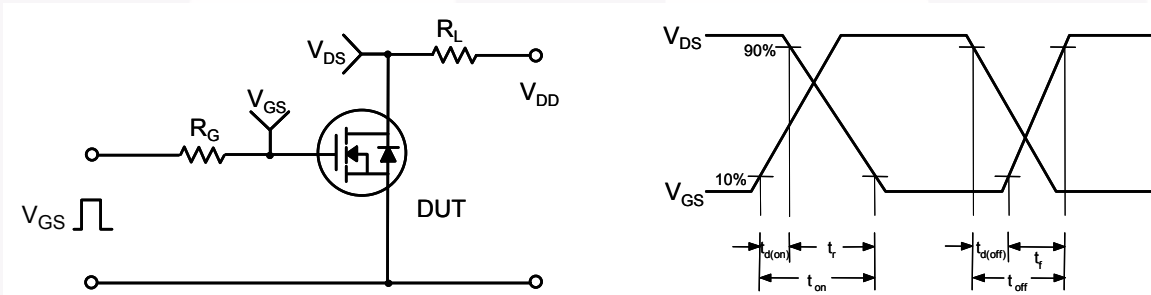


Figure 13. Resistive Switching Test Circuit & Waveforms

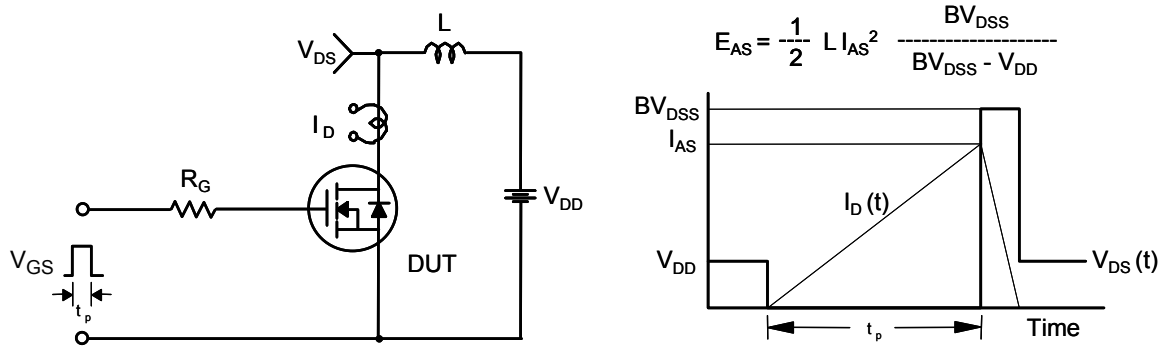


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

$$E_{AS} = \frac{1}{2} L I_{AS}^2 \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$

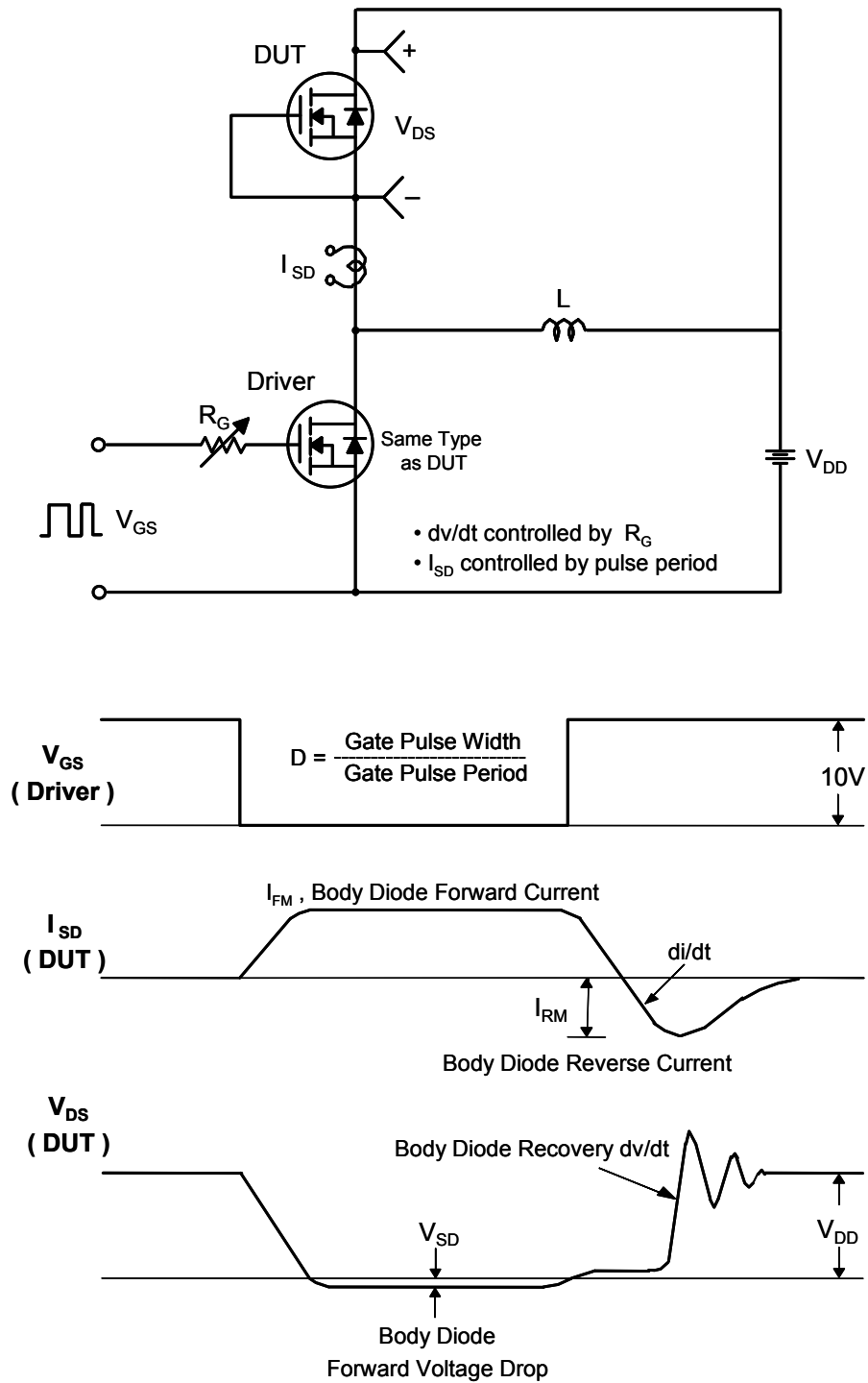
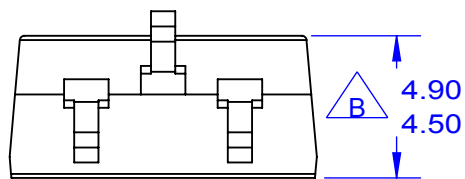
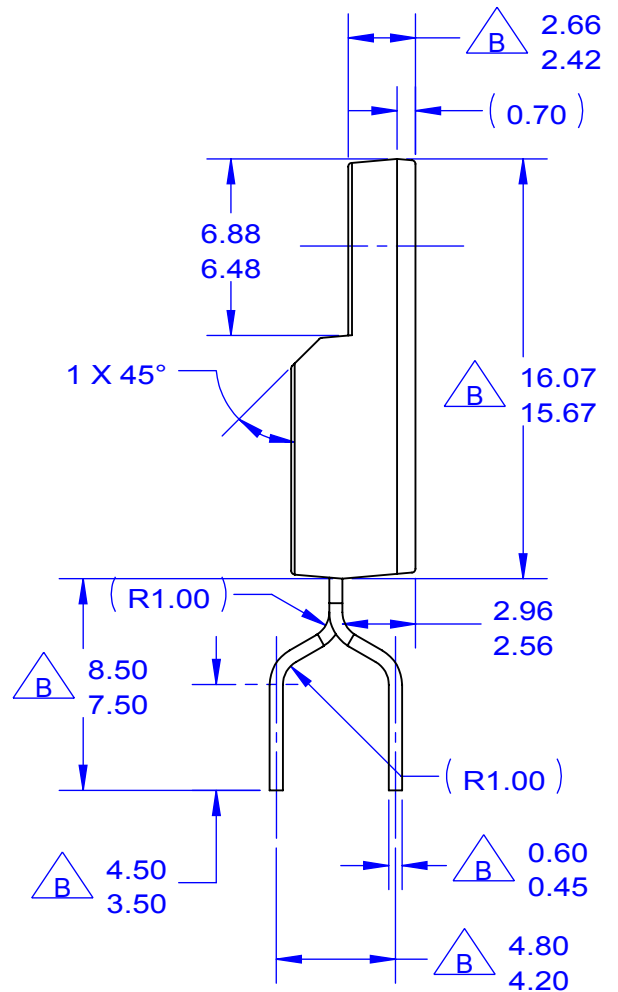
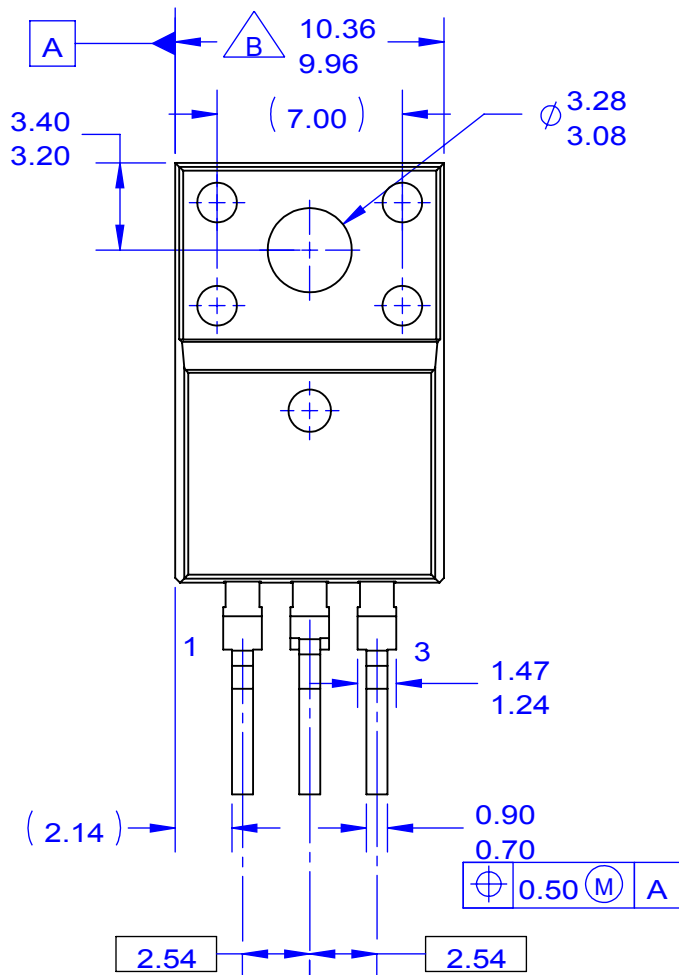


Figure 15. Peak Diode Recovery $d v / d t$ Test Circuit & Waveforms

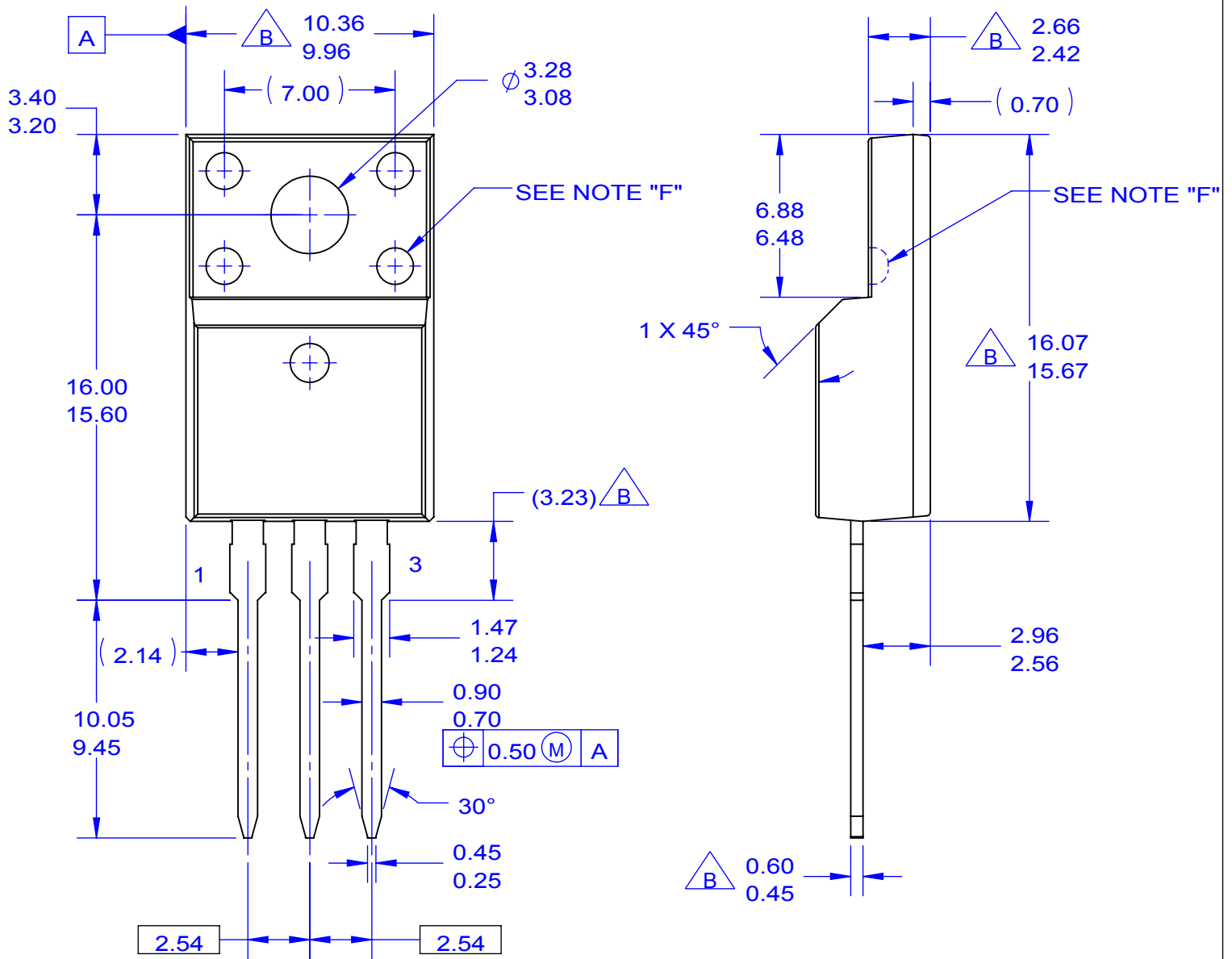


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- F. OPTION 1 - WITH SUPPORT PIN HOLE.
OPTION 2 - NO SUPPORT PIN HOLE.
- G. DRAWING FILE NAME: TO220M03REV5

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